

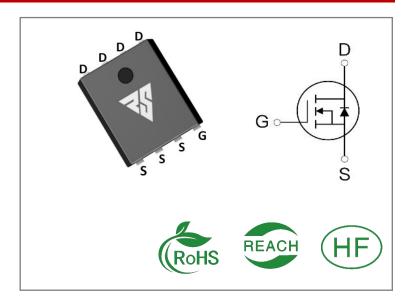
| ID | R _{DS} (ON)(Typ) | VDSS |
|------|---------------------------|------|
| 100A | 2.7mΩ | 40V |

Applications:

- Load Switch
- PWM Applications
- Power Managment

Features:

- Fast switching speed
- 100% avalanche tested
- Improved dv/dt capability



Ordering Information

| Part Number | Package | Marking | Packing | Qty. |
|-------------|---------|------------|-----------|----------|
| RS40N100HG | DFN5*6 | RS40N100HG | Tape&reel | 5000 PCS |

Absolute Maximun Ratings Tc= 25℃ unless otherwise specified

| Symbol | Parameter | RS40N100HG | Units |
|----------------|---|------------|-------------------------|
| VDSS | Drain-to-Source Voltage | 40 | V |
| ID | Continuous Drain Current TC=25℃ | 100 | |
| ID | Continuous Drain Current TC=100℃ | 65 | Α |
| IDM | Pulsed Drain Current (Note*1) | 400 | |
| PD | Power Dissipation | 61 | W |
| VGS | Gate- to- Source Voltage | ±25 | V |
| EAS | Single Pulse Avalanche Engergy L = 0.5mH, VDD = 20V, RG = 25 Ω ,TC=25 $^{\circ}$ C | 195 | mJ |
| TI TDVC | Maximum Temperature for Soldering | 300 | |
| TL TPKG | Leads at 0.063in(1.6mm)from Case for 10 seconds Package Body for 10 seconds | 260 | $^{\circ}\! \mathbb{C}$ |
| TJ and TSTG | Operating Junction and Storage Temperature Range | -55 to 150 | |

^{*} Drain Current Limited by Maximum Junction Temperature

Caution: Stresses greater than those listed in the "Absolute Maximum Ratings" Table may cause permanent damage to the device.



Thermal Resistance

| Symbol | Parameter | RS40N100HG | Units | Test Conditions |
|--------|-------------------------|------------|-------|---|
| RθJC | Junction-to-Case | 2 | °C/W | Drain lead soldered to water cooled heatsink, PD adjusted for a peak junction temperature of + 1 5 0 $^{\circ}$ C |
| RθJA | Junction-to- Ambient | 32 | | 1 cubic foot chamber,free air. |

OFF Characteristics TJ= 25 [°]C unless otherwise specified

| Symbol | Parameter | Min. | Тур. | Max. | Units | Test Conditions |
|--------|--|------|------|------|-------|----------------------|
| BVDSS | Drain- to- source Breakdown Voltage | 40 | - 1 | | ٧ | VGS=0V,ID=250μA |
| IDSS | Drain- to- Source Leakage Current | | | 1 | μΑ | VDS=40V,VGS=0V |
| | Gate- to- Source Forward Leakage | | | 100 | | VGS=25V ,VDS=0V |
| IGSS | Gate- to- Source Reverse Leakage | | | -100 | nA | VGS=-25V ,VDS=0 V |

ON Characteristics TJ=25°C unless otherwise specified

| Symbol | Parameter | Min. | Тур. | Max. | Units | Test Conditions |
|----------|---|------|------|------|-------|----------------------|
| RDS(on) | n) Static Drain- to- Source On- Resistance(Note*2) | | 2.7 | 3.5 | mΩ | VGS=10V,ID=30A |
| RD3(0II) | | | 3.6 | 4.8 | mΩ | VGS=4.5V,ID=20A |
| VGS(TH) | Gate Threshold Voltage | 2 | | 4 | V | VGS=VDS,ID=250μ A |

Resistive Switching Characteristics Essentially independent of operating temperature

| Symbol | Parameter | Min. | Тур. | Max. | Units | Test Conditions |
|---------|----------------------|------|------|------|-------|---------------------------------------|
| td(ON) | Turn- on Delay Time | | 20 | | | VDS=20V ID=30A RG=3Ω VGS=10V |
| trise | Rise Time | | 32 | | nS | |
| td(OFF) | Turn- OFF Delay Time | | 72 | | | |
| tfall | Fall Time | | 40 | | | VG3 10V |





Dynamic Characteristics Essentially independent of operating temperature

| Symbol | Parameter | Min. | Тур. | Max. | Units | Test Conditions |
|--------|---------------------------------|------|------|------|-------|-----------------|
| Ciss | Input Capacitance | | 4885 | | | VGS=0V |
| Coss | Output Capacitance | | 527 | | pF | VDS=20V |
| Crss | Reverse Transfer Capacitance | | 315 | | | f=1MHz |
| Qg | Total Gate Charge | | 80 | | | VDS=20V |
| Qgs | Gate- to- Source Charge | | 18 | | nC | ID=30A |
| Qgd | Gate-to-Drain(" Miller") Charge | | 21 | | | VGS=10V |

Source-Drain Diode Characteristics

| Symbol | Parameter | Min. | Тур. | Max. | Units | Test Conditions |
|--------|---------------------------|------|------|------|-------|--------------------|
| IS | Continuous Source Current | | | 100 | Α | Integral pn- diode |
| ISM | Maximum Pulsed Current | | | 400 | Α | in MOSFET |
| VSD | Diode Forward Voltage | | | 1.2 | V | IS=30A,VGS=0V |
| trr | Reverse Recovery Time | | 27 | | nS | IS=30A |
| Qrr | Reverse Recovery Charge | | 45 | | nC | di/dt=100A/μs |

Notes:

^{* 1.} Repetitive rating, pulse width limited by maximum junction temperature.

^{* 2.} Pulse Test: Pulse width ≤ 300μs, Duty Cycle ≤ 0.5%



Typical Feature Curve

Figure1: Output Characteristics

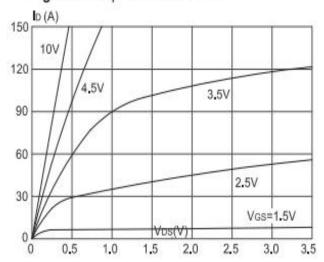


Figure 3:On-resistance vs. Drain Current

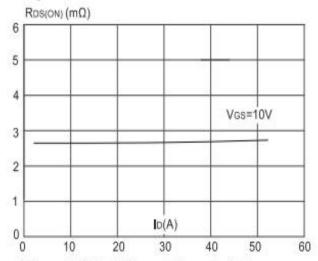


Figure 5: Gate Charge Characteristics

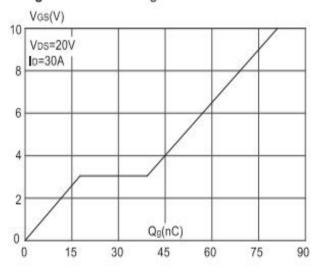


Figure 2: Typical Transfer Characteristics

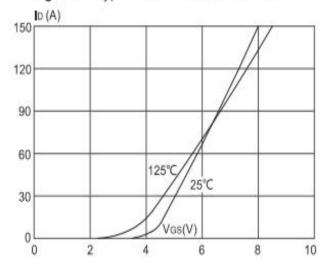


Figure 4: Body Diode Characteristics

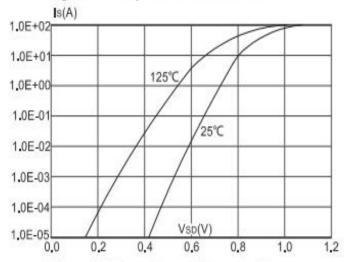
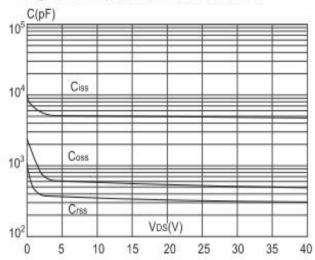


Figure 6: Capacitance Characteristics



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Figure 7: Normalized Breakdown Voltage vs. Junction Temperature

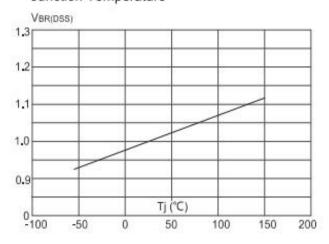


Figure 9: Maximum Safe Operating Area

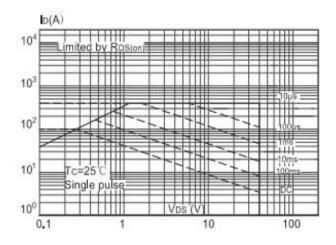


Figure.11: Maximum Effective Transient Thermal Impedance, Junction-to-Case

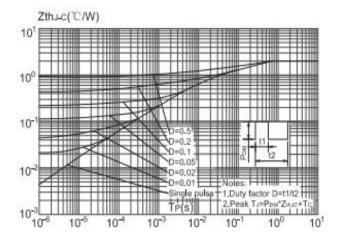


Figure 8: Normalized on Resistance vs. Junction Temperature

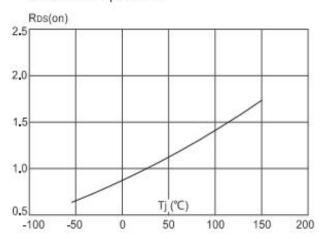
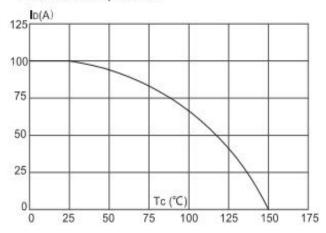


Figure 10: Maximum Continuous Drain Current vs. Case Temperature



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Test ircuits and Waveforms

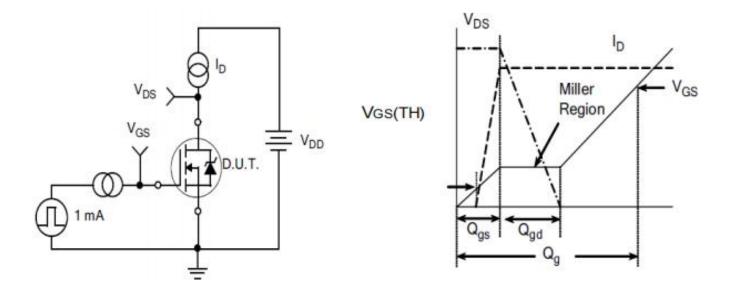


Figure A.
Gate Charge Test Circuit

Figure B. Gate Charge Waveform

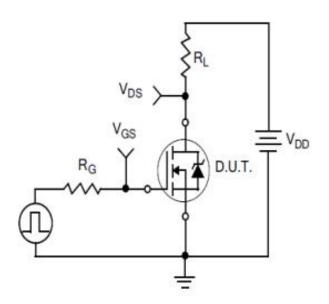


Figure C.
Resistive Switching Test Circuit

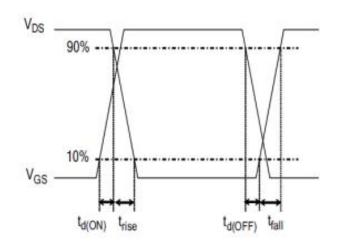


Figure D.
Resistive Switching Waveforms



Test Circuits and Waveforms

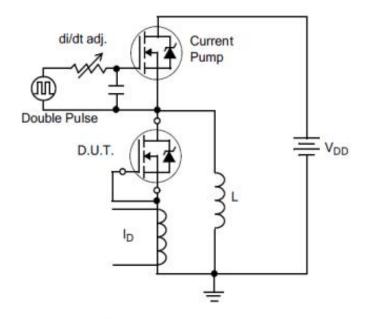


Figure E.Diode Reverse Recovery Test Circuit

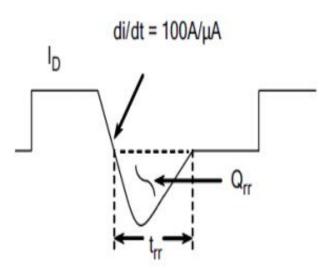


Figure F.Diode Reverse Recovery Waveform

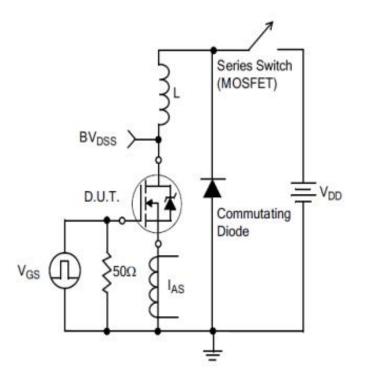


Figure G.Unclamped Inductive Switching Test Circuit

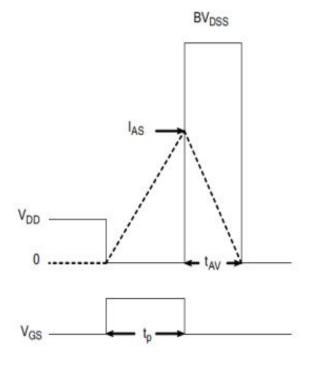
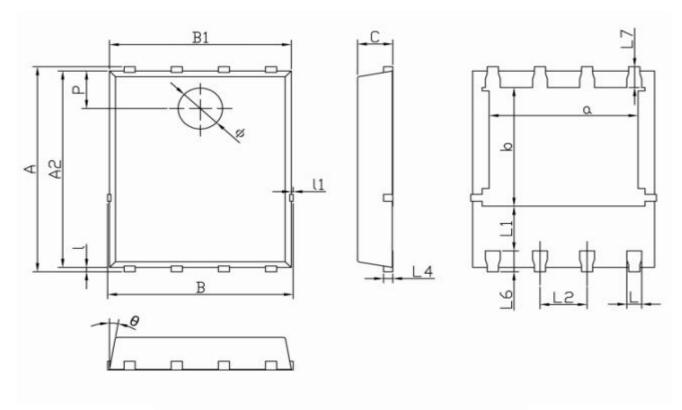


Figure H.Unclamped Inductive Switching Waveforms



Package outline drawing(DFN5*6 Unit: mm)



| D | imensior Millimet | | |
|--------|----------------------|------|------|
| Symbol | MIN | TYP | MAX |
| Α | 5.90 | 6.00 | 6.10 |
| a | 3.91 | 4.01 | 4.11 |
| A2 | 5.70 | 5.75 | 5.80 |
| В | 4.90 | 5.00 | 5.10 |
| b | 3.37 | 3.47 | 3.57 |
| B1 | 4.80 | 4.90 | 5.00 |
| С | 0.90 | 0.95 | 1.00 |
| L | 0.35 | 0.40 | 0.45 |
| ι | 0.06 | 0.13 | 0.20 |
| ∟1 | 1.10 | _ | _ |
| l1 | _ | 1_ | 0.10 |
| L2 | 1.17 | 1.27 | 1.37 |
| L4 | 0.21 | 0.26 | 0.34 |
| L6 | 0.51 | 0.61 | 0.71 |
| L7 | 0.51 | 0.61 | 0.71 |
| Р | 1.00 | 1.10 | 1.20 |
| θ | 8° | 10° | 12° |
| ф | 1.10 | 1.20 | 1.30 |



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DMN2080UCB4-7 DMN61D9UWQ-13 US6M2GTR DMN31D5UDJ-7 DMP22D4UFO-7B DMN1006UCA6-7 DMN16M9UCA6-7
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